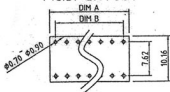


P.C.B. LAYOUT



Contact	DIM A	DIM B	Contact	DIM A	DIM B
06	7.62	5.08	18	22.86	20.32
08	10.16	7.62	20	25.40	22.86
10	12.70	10.16	24	30.48	27.94
14	17.78	15.24			
16	20.32	17.78			

Pin:  
Clip:

brass, machined, CuZn38Pb2  
 contact 4 finger: Beryllium copper, heat treated  
 plating: HZL = Pin - 200 $\mu$ " / Clip - gold flash  
 HGL = Pin - gold flash / Clip - gold flash

Insulator body:  
 Current rating:  
 Contact resistance:  
 Insulations resistance:  
 Operating:  
 Operating temperature:

polyamide ( glass filled ) , UL94V-0  
 3A / contact max.  
 <math><4\text{m}\Omega</math> / contact  
 >1000Mohm at V=100V  
 60 vac / dc  
 gold plated: -55 $^{\circ}$ C to +125 $^{\circ}$ C  
 tin plated: -40 $^{\circ}$ C to +105 $^{\circ}$ C

Soldering temperature:  
 Mechanical life:

+260 $^{\circ}$ C, 10s max.  
 min.200

	Datum	Name
Bearb.	07.11.01	Helwig
Gepr.	07.11.01	<i>Helwig</i>
Norm.		

IC-sockets  
 with machined pins  
 AR xx - HZL-TT  
 AR xx - HGL-TT

**ASSMANN**  
 Electronic Components

Ersatz für ASS 0337 CO  
 dd. 19.06.2001

Blatt  
 1/1

Blatt